

Description: micro dynamic speaker

Date: 10/18/2006

Unit: mm

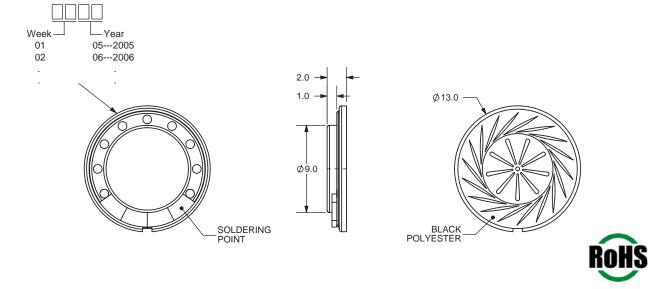
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## **Specifications**

Dimensions	ø13.0 x 2.0 mm	l			
Impedance	8 Ohm ± 15%		at	1.5 KHz 1 V	
Resonant frequency	1050 Hz ± 20%		at	1 V	
Sound pressure level	86 dB/w ± 3 dB		0.2 w 1	0 cm at 1.5K, 2.	.0K, 2.5K, 3.0K Hz
	$75 \text{ dB/w} \pm 3 \text{ dB}$		1 w 1m	at 1.5K, 2.0K,	2.5K, 3.0K Hz
Response	Fo Hz ~ 20 KHz	z max.			
Distortion	10% max.		at 1.5 k	KHz 0.2W	
Input power	Nominal	0.2 W	Handlir	ng capacity	0.4 W
Operation	must be normal at program source 0.2 W				
Buzz, rattle, etc.	must be normal at sine wave 1.26 V				
Magnet	ø7.0 x 0.7 (Nd-Fe-B)				
Operating temp.	-20 ~ +55°C				
Weight	0.7 g				
Material	Metal			_	
RoHS	yes				

## **Mechanical Drawing**

Tolerance: ±0.3

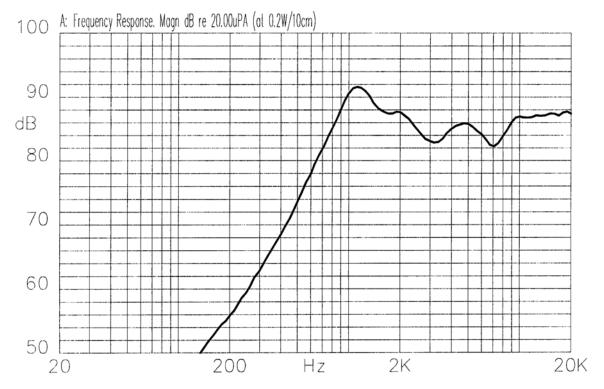


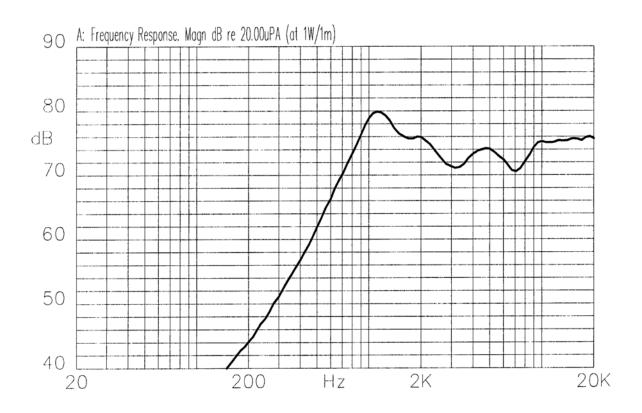
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## **Frequency Response Curve**





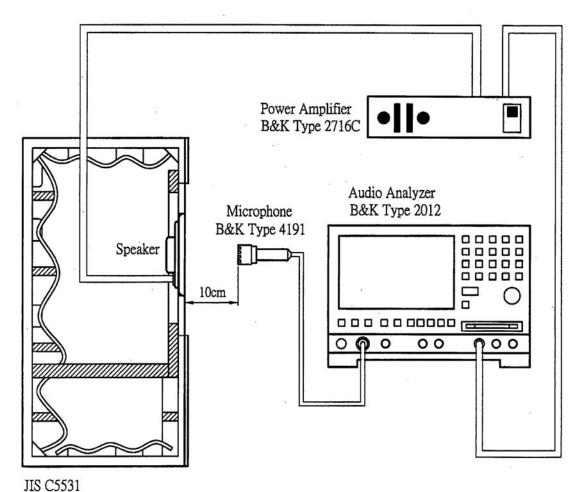
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#### **Measurement Circuit**



940mm x 640mm x 1240mm



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#### **Mechanical Characteristics**

Item	Test Condition	<b>Evaluation Standard</b>
PCB Wire Pull Strength	The pull force should be applied to double lead	
	wire:	No damage or cutting off.
	Horizontal 3.0N (0.306kg) for 30 seconds	
Vibration	The speaker should be measured after applying	
	a vibration amplitude of 1.5 mm with 10 to	No obstacle will be harmful to
	55 Hz band of vibration frequency to each of	normal operation; damage,
	the 3 perpendicular directions for 2 hours.	cracks, rust, and distortions.
Drop Test	The part will be dropped, contained inside a	Should not be audible at 1.26 V
	normal box, from a height of 75 cm onto a 40	sine wave between Fo ~ 20 KHz.
	mm thick wooden board 10 times.	

#### **Environment Test**

Item	Test Condition	Evaluation Standard
High temp. test	After being placed in a chamber at 55°C for 96 hours.	
Low temp. test	After being placed in a chamber at -20°C for 96 hours.	
Humidity test	After being placed in a chamber at +40°C and 90% relative humidity for 240 hours.	The speaker will be measured after being placed at +25°C for 6 hours. No obstacle will be harm ful to normal operation; damage, cracks, rust, and distortions. Should not be audible at 1.26 V sine wave between Fo ~ 20 KHz. The SPL should be within ±3dB compared to the initial measurements.
Temp. cycle test	90% relative humidity for 240 hours.  The part shall be subjected to 5 cycles. One cycle will consist of:  +55°C  -20°C  2hrs hr 1hr 2hrs  6hrs	



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**Reliability Test** 

0.2 W white noise, applied for 96 hours, at	The speaker will be measured
room temperature.	after being placed at +25°C for 6 hours. No obstacle will be harm ful to normal operation; damage, cracks, rust, and distortions. Should not be audible at 1.26 V sine wave between Fo ~ 20 KHz. The SPL should be within ±3dB compared to the initial measurements.
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### **Test Conditions**

Standard Test Condition
Judgement Test Condition

a) Tempurature: +5 ~ +35°C a) Tempurature: +25 ±2°C b) Humidity: 45 - 85% b) Humidity: 60 - 70% c) Pressure: 860-1060 mbar c) Pressure: 860-1060 mbar

**Recommended Temperature Profile for Hand Soldering** 

Hand Soldering 370±10°C / 3±1 Sec

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# **Packaging**

